



### APT40GR120B2SCD10

1200V, 40A,  $V_{CE(on)}$ = 2.5V Typical

## Ultra Fast NPT - IGBT®

The Ultra Fast NPT - IGBT<sup>®</sup> is a new generation of high voltage power IGBTs. Using Non-Punch-Through Technology, the Ultra Fast NPT-IGBT<sup>®</sup> offers superior ruggedness and ultrafast switching speed.

### **Features**

- Low Saturation Voltage
- Low Tail Current
- RoHS Compliant 💋

- Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current

Combi (IGBT and Diode)

Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).

### MAXIMUM RATINGS

All Ratings:  $T_c = 25^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Ratings	Unit
V <sub>ces</sub>	Collector Emitter Voltage	1200	V
$V_{GE}$	Gate-Emitter Voltage	±30	V
I <sub>C1</sub>	Continuous Collector Current @ $T_c = 25^{\circ}C$	88	
I <sub>C2</sub>	Continuous Collector Current @ T <sub>c</sub> = 110°C	40	А
I <sub>CM</sub>	Pulsed Collector Current ①	160	
SCWT	Short Circuit Withstand Time: $V_{ce}$ = 600V, $V_{ge}$ = 15V, $T_c$ =125°C	10	μs
P <sub>D</sub>	Total Power Dissipation @ $T_c = 25^{\circ}C$	500	W
T_,T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to 150	<u>.</u>
TL	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	

### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Max	Unit
V <sub>(BR)CES</sub>	Collector-Emitter Breakdown Voltage ( $V_{GE} = 0V, I_{C} = 1.0mA$ )	1200			
V <sub>GE(TH)</sub>	Gate Threshold Voltage ( $V_{CE} = V_{GE}$ , $I_{C} = 2.0$ mA, $T_{j} = 25^{\circ}$ C)	3.5	5.0	6.5	) / - I4 -
V <sub>CE(ON)</sub>	Collector-Emitter On Voltage ( $V_{GE}$ = 15V, $I_{C}$ = 40A, $T_{j}$ = 25°C)		2.5	3.2	Volts
	Collector-Emitter On Voltage ( $V_{GE}$ = 15V, $I_{C}$ = 40A, $T_{j}$ = 125°C)		3.5		
	Collector-Emitter On Voltage ( $V_{GE}$ = 15V, $I_{C}$ = 88A, $T_{j}$ = 25°C)		3.5		
I <sub>ces</sub>	Collector Cut-off Current (V <sub>CE</sub> = 1200V, V <sub>GE</sub> = 0V, T <sub>j</sub> = 25°C) <sup>(2)</sup>			1200	μA
020	Collector Cut-off Current ( $V_{CE}$ = 1200V, $V_{GE}$ = 0V, $T_j$ = 125°C) <sup>(2)</sup>		300		
I <sub>GES</sub>	Gate-Emitter Leakage Current (V <sub>GE</sub> = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.



### DYNAMIC CHARACTERISTICS

### APT40GR120B2SCD10

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C <sub>ies</sub>	Input Capacitance	Capacitance		3980		
C <sub>oes</sub>	Output Capacitance	$V_{_{\rm GE}}$ = 0V, $V_{_{\rm CE}}$ = 25V		510		pF
C <sub>res</sub>	Reverse Transfer Capacitance	f = 1MHz		80		
V <sub>GEP</sub>	Gate to Emitter Plateau Voltage	Cata Charge		7		V
Q <sub>q</sub> 3	Total Gate Charge	Gate Charge		210		
Q <sub>ge</sub>	Gate-Emitter Charge	$V_{gE} = 15V$		25		
Q <sub>gc</sub>	Gate- Collector Charge	- V <sub>CE</sub> = 600V I <sub>C</sub> = 40A		90		nC
t <sub>d(on)</sub>	Turn-On Delay Time	Inductive Switching (25°C)	1	20		
t,	Current Rise Time	V <sub>cc</sub> = 600V		21		
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GE</sub> = 15V		166		ns
t <sub>r</sub>	Current Fall Time	I <sub>с</sub> = 40А		42	1	
E <sub>on</sub> (5)	Turn-On Switching Energy	R <sub>G</sub> = 4.3 Ω <sup>(4)</sup>		929	1800	1
E <sub>off</sub>	Turn-Off Switching Energy	T <sub>J</sub> = +25°C		1070	1650	μJ
t <sub>d(on)</sub>	Turn-On Delay Time	Inductive Switching (125°C)		20		
t,	Current Rise Time	V <sub>cc</sub> = 600V		20		
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GE</sub> = 15V		187		ns
t <sub>r</sub>	Current Fall Time	I <sub>c</sub> = 40A		48		
E <sub>on</sub> 5	Turn-On Switching Energy	$R_{g} = 4.3 \ \Omega^{(4)}$		971	2000	1
E <sub>off</sub>	Turn-Off Switching Energy	T <sub>J</sub> = +125°C		1042	2500	μJ

### THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic	Min	Тур	Max	Unit
R <sub>ejc</sub>	Junction to Case Thermal Resistance (IGBT)			.25	°C/W
	Junction to Case Thermal Resistance (Diode)			1.00	
R <sub>eja</sub>	Junction to Ambient Thermal Resistance			40	
W <sub>T</sub>	Package Weight		.22		oz
	r aunaye weiyin		6.2		g

1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

2 Pulse test: Pulse Width <  $380\mu s$ , duty cycle < 2%.

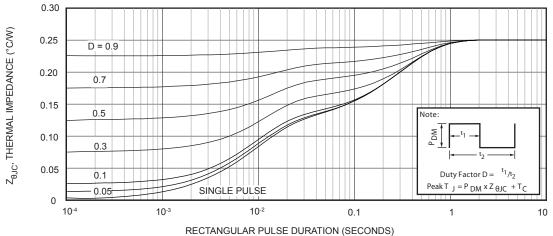
3 See Mil-Std-750 Method 3471.

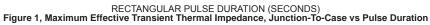
4 R<sub>g</sub> is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)

5 E<sub>on</sub> is the clamped inductive turn on energy that includes a commutating diode reverse transient current in the IGBT turn on energy loss. A combi device is used for the clamping diode.

6 E<sub>off</sub> is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

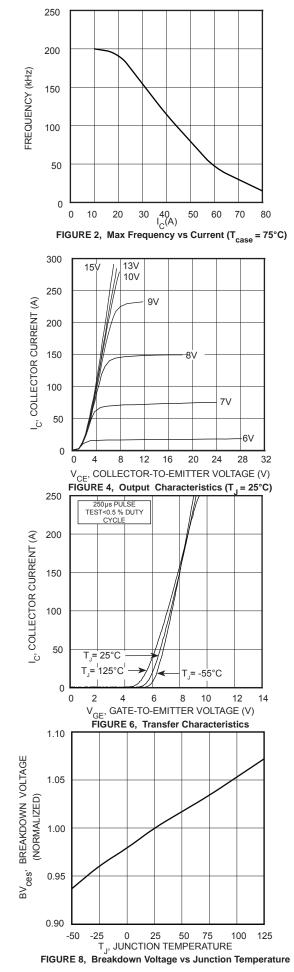
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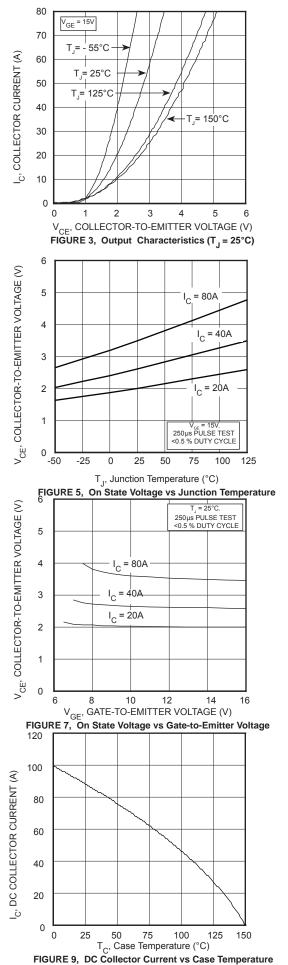


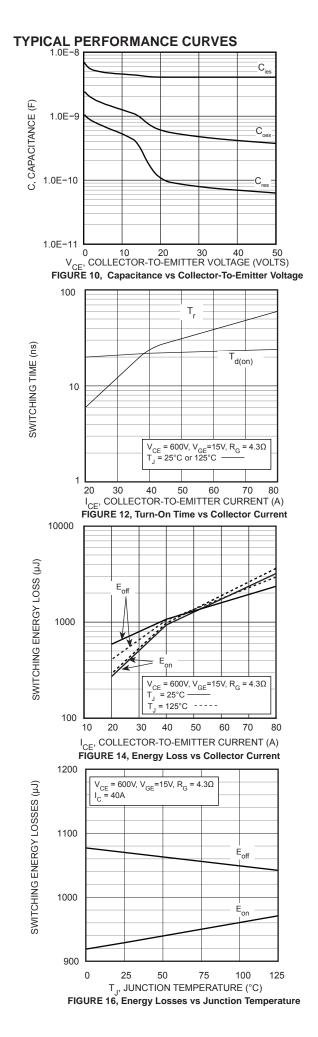


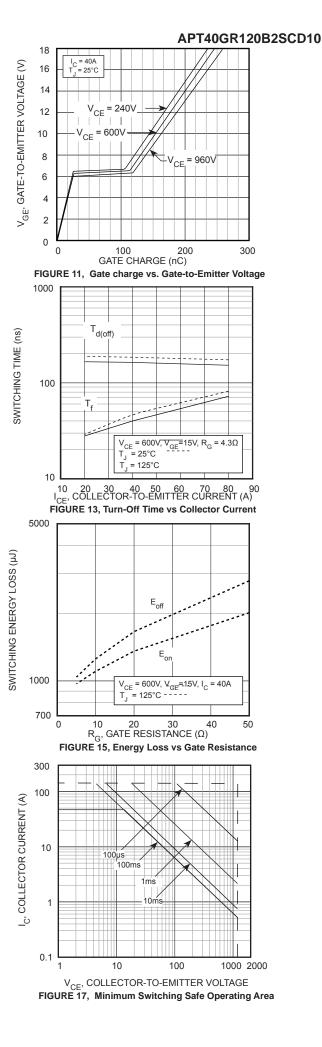
### **TYPICAL PERFORMANCE CURVES**

### APT40GR120B2SCD10









# 052-6406 Rev A 12-2012

# ZERO RECOVERY LOW LEAKAGE SIC ANTI-PARALLEL DIODE

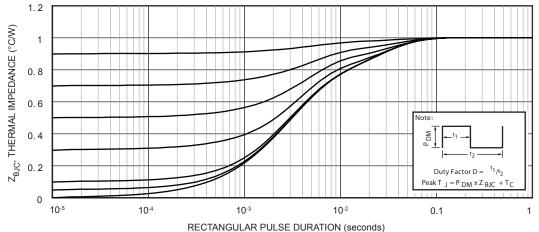
### **MAXIMUM RATINGS**

All Ratings:  $T_{C} = 25^{\circ}C$  unless otherwise specified.

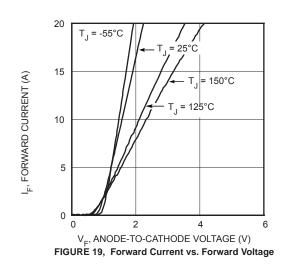
Symbol	Characteristic / Test Conditions		Ratings	Unit
	Maximum D.C. Forward Current	T <sub>c</sub> = 25°C	36	
I <sub>F</sub>		T <sub>c</sub> = 135°C	10	
I <sub>FRM</sub>	Repetitive Peak Forward Surge Current ( $T_j = 45^{\circ}C$ , $t_p = 10$ ms, Half Sine Wave)		50	Amps
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current (T <sub>j</sub> = 25°C, $t_p = 1$	110		

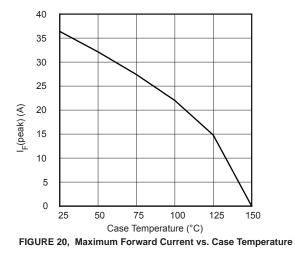
### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		Min	Тур	Max	Unit	
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 10A T <sub>J</sub> = 25°C		1.5		Volts	
		I <sub>F</sub> = 10A, T <sub>J</sub> = 150°C		2.1			
Q <sub>c</sub>	Total Capactive Charge V <sub>R</sub> = 800V, I <sub>F</sub> = 10A, di/dt = -100A/ $\mu$ s, T <sub>J</sub> = 25°C			30		nC	
	Junction Capacitance $V_{R} = 0V$ , $T_{J} = 25^{\circ}C$ , f = 1MHz			600			
C <sub>T</sub>	Junction Capacitance $V_R = 200V$ , $T_J = 25^{\circ}C$ , f = 1MHz			71		pF	
	Junction Capacitance $V_{R}$ = 400V, $T_{J}$ = 25°C, f = 1MHz			52			



RECTANGULAR PULSE DURATION (seconds) FIGURE 18. MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs. PULSE DURATION



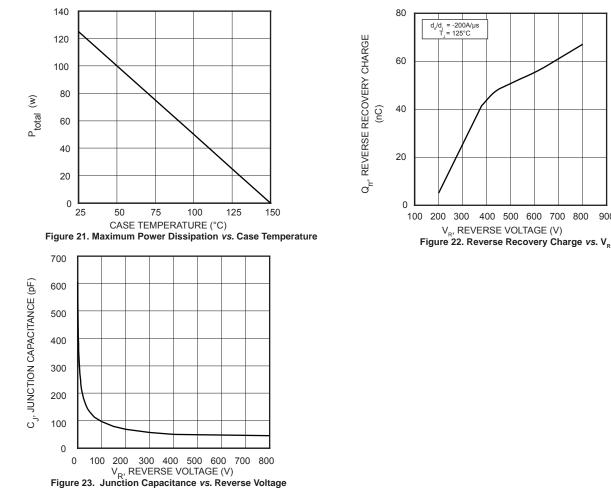


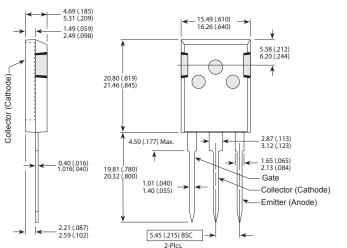
052-6406 Rev B 5-2020

#### **TYPICAL PERFORMANCE CURVES**

### APT40GR120B2SCD10

900





## T-MAX<sup>®</sup> (B2) Package Outline

These dimensions are equal to the TO-247 without the mounting hole. Dimensions in Millimeters and (Inches)

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